



DDR2 SO DIMM

TE Internal #: 1473005-4

Double Data Rate (DDR) 2, 5.2 mm [.205 in] Stack Height, Right Angle Module Orientation, 200 Position, DDR2 SO DIMM, SO DIMM Sockets

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Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets > DDR2 SO DIMM Sockets



DRAM Type: **Double Data Rate (DDR) 2**

Stack Height: **5.2 mm [.205 in]**

Module Orientation: **Right Angle**

Number of Positions: **200**

Centerline (Pitch): **.6 mm [.024 in]**

[All DDR2 SO DIMM Sockets \(28\)](#)

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Cable-to-Board
DRAM Type	Double Data Rate (DDR) 2

Configuration Features

Number of Bays	2
Number of Keys	1
Number of Rows	2
Module Orientation	Right Angle
Number of Positions	200

Electrical Characteristics

DRAM Voltage	1.8 V
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Signal Characteristics



SGRAM Voltage	1.8 V
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Body Features

Latch Plating Material	Tin
Latch Material	Stainless Steel
Module Key Type	SGRAM
Ejector Type	Locking
Ejector Location	Both Ends
Connector Profile	Standard

Contact Features

Contact Current Rating (Max)	.5 A
Memory Socket Type	Memory Card
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Gold Flash
Contact Mating Area Plating Material	Gold Flash

Termination Features

Insertion Style	Cam-In
Termination Method to PCB	Surface Mount

Mechanical Attachment

Connector Mounting Type	Board Mount
Mating Alignment Type	Standard Keying
PCB Mount Retention Type	Solder Peg
PCB Mount Retention	With

Housing Features

Housing Color	Black
Housing Material	High Temperature Thermoplastic
Centerline (Pitch)	.6 mm[.024 in]

Dimensions

Stack Height	5.2 mm[.205 in]
Row-to-Row Spacing	6.2 mm[.244 in]

Usage Conditions

Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
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Operation/Application



Circuit Application	Power
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Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Quantity	20
Packaging Method	Semi-Hard Tray Assembly

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 245°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts





TE Part # 2309407-1
DDR4 SODIMM 260P 4.0H STD

TE Part # 1932208-1
EMBOSS TAPE DDR3 204P 5.2H RVS

TE Part # 1932210-1
EMBOSS TAPE DDR3 204P 9.2H RVS

TE Part # 1932317-4
EMBOSS ASSY DDR2 SODIMM
SOCKET 200P 9.2H

Also in the Series | DDR2 SO DIMM



SO DIMM Sockets(24)

Customers Also Bought



TE Part #9-2176231-4
3522 75K 1% 3W



TE Part #ZPF00000000110280
732-8255-20



TE Part #2102155-2
Fortis Zd 3Pr 10Col R/A Full Shrd Assy



TE Part #2176346-7
CRGCQ 1210 10R 5%



TE Part #9-1415535-3
0410 63 050 005WG



TE Part #7-1614894-1
CPF0805 1M1 0.1% 25PPM 5K RL



TE Part #3-2176347-6
CRGCQ 2010 8K2 1%

TE Part #WM11BF06-09PN-990A
RECP ASSY

TE Part #2828645-1
ASSY PIN MODULE, 16-02 PCB
STRAIGHT, LOW

TE Part #2828646-1
ASSY SKT MODULE, 16-02 PCB
STRAIGHT, LOW



Documents

Product Drawings

[SEMI-HARD TRAY DDR2 SODIMM SOCKET 200P 5](#)

English

CAD Files

Customer View Model

[ENG_CVM_CVM_1473005-4_J1.2d_dxf.zip](#)

English

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_1473005-4_J1.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1473005-4_J1.3d_stp.zip](#)

English

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Product Specifications

[Product Specification](#)

English

Agency Approvals

[Agency Approval Document](#)

English